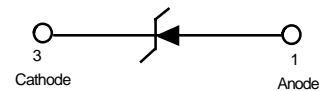
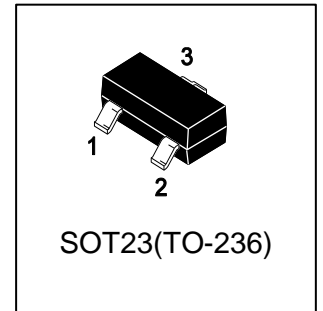


LBZX84C12LT1G

S-LBZX84C12LT1G

Zener Voltage Regulator Diodes

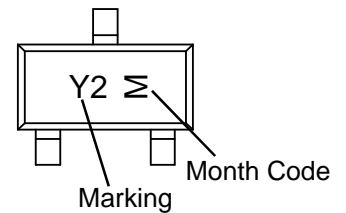


1. FEATURES

- We declare that the material of product compliance with RoHS requirements and Halogen Free.
- S- prefix for automotive and other applications requiring unique site and control change requirements; AEC-Q101 qualified and PPAP capable.

2. DEVICE MARKING AND ORDERING INFORMATION

| Device | Marking | Shipping |
|---------------|---------|-----------------|
| LBZX84C12LT1G | Y2 | 3000/Tape&Reel |
| LBZX84C12LT3G | Y2 | 10000/Tape&Reel |



3. THERMAL CHARACTERISTICS

| Parameter | Symbol | Limits | Unit |
|--|-----------------------------------|------------|-------------|
| Total Device Dissipation, FR-5 Board (Note 1) @ TA = 25°C Derate above 25°C | PD | 225 1.8 | mW mW/°C |
| Thermal Resistance Junction-to-Ambient | R θ JA | 556 | °C/W |
| Total Device Dissipation, Alumina Substrate (Note 2) @ TA = 25°C Derate above 25°C | PD | 300 2.4 | mW mW/°C |
| Thermal Resistance Junction-to-Ambient | R θ JA | 417 | °C/W |
| Junction and Storage temperature | T _J , T _{stg} | -55 ~ +150 | °C |

1.FR-5 = 1.0 × 0.75 × 0.062 in.

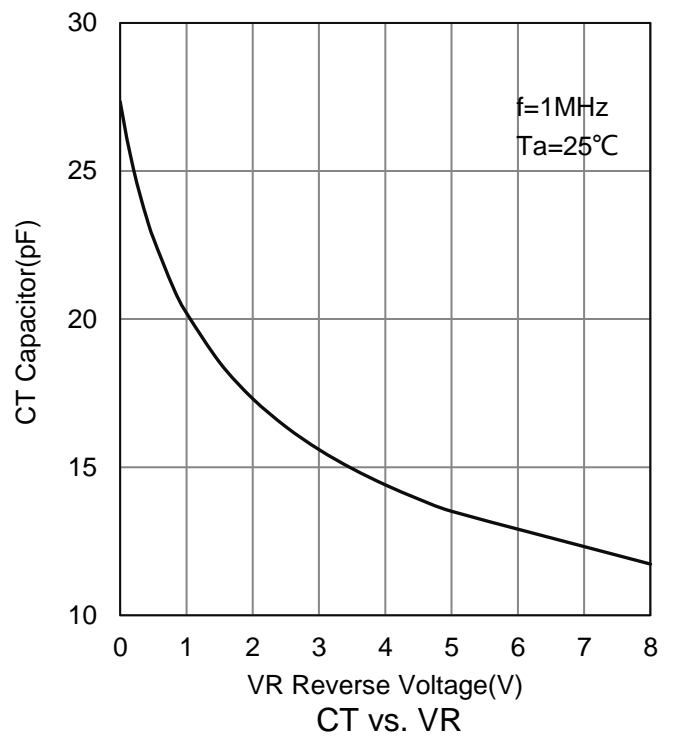
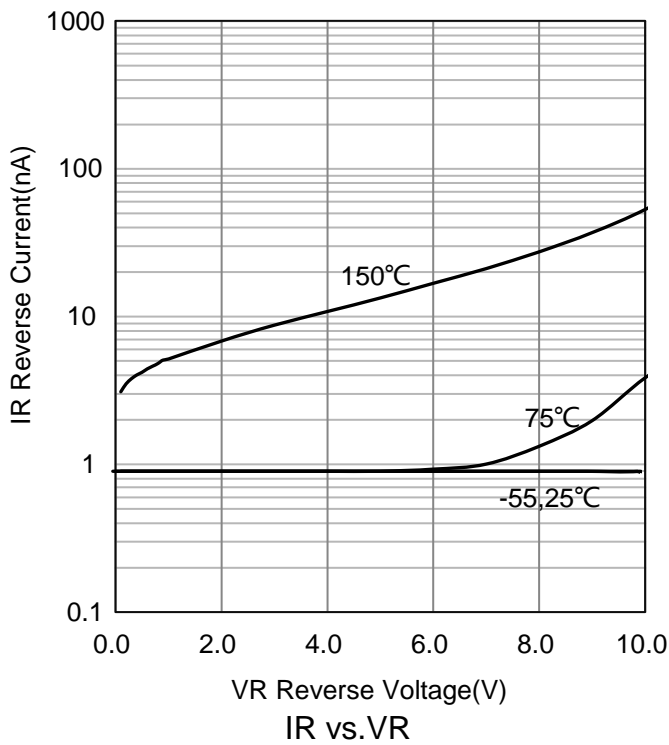
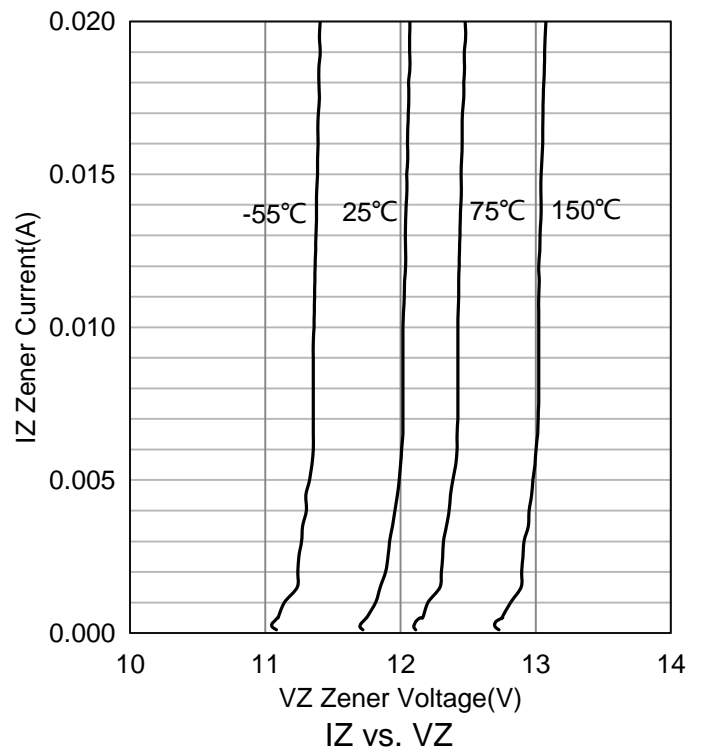
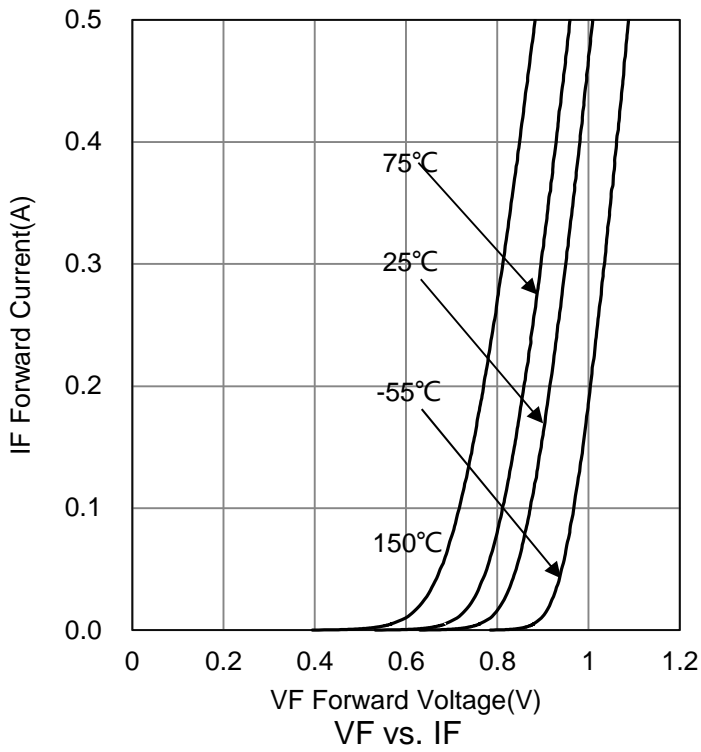
2.Alumina = 0.4 × 0.3 × 0.024 in. 99.5% alumina.

4. ELECTRICAL CHARACTERISTICS (Ta= 25°C)

| Characteristic | Symbol | Min. | Typ. | Max. | Unit |
|---|--------|----------------------|--------------|----------------------|-------|
| Zener Voltage(Note 3) (IZT1 = 5 mA) (IZT2 = 1 mA) (IZT3 = 20 mA) | VZ | 11.4 11.2 11.4 | 12 - - | 12.7 12.7 12.9 | V |
| Zener Impedance (IZT1 =5mA) (IZT1 =1mA) (IZT1 =20mA) | ZZT | - - - | - - - | 25 150 10 | Ohm |
| Reverse Leakage Current (VR=8V) | IR | - | - | 0.1 | μA |
| Capacitance (VR=0,f=1MHz) | C | - | 130 | - | pF |
| Temperature Coefficient (IZT1 = 5 mA) | θVZ | 6 | - | 10 | mV/°C |

3.Zener voltage is measured with a pulse test current IZ at an ambient temperature of 25°C.

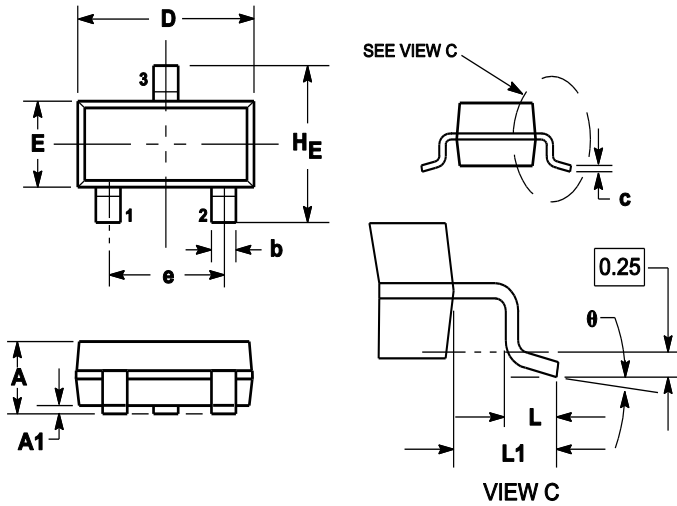
5.ELECTRICAL CHARACTERISTICS CURVES



6. OUTLINE AND DIMENSIONS

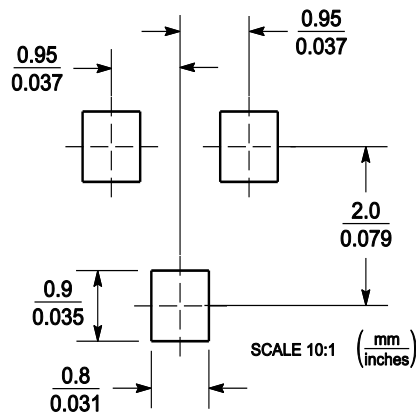
Notes:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.



| DIM | MILLIMETERS | | | INCHES | | |
|----------|-------------|------|------|--------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.89 | 1 | 1.11 | 0.035 | 0.04 | 0.044 |
| A1 | 0.01 | 0.06 | 0.1 | 0.001 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.5 | 0.015 | 0.018 | 0.02 |
| c | 0.09 | 0.13 | 0.18 | 0.003 | 0.005 | 0.007 |
| D | 2.80 | 2.9 | 3.04 | 0.11 | 0.114 | 0.12 |
| E | 1.20 | 1.3 | 1.4 | 0.047 | 0.051 | 0.055 |
| e | 1.78 | 1.9 | 2.04 | 0.07 | 0.075 | 0.081 |
| L | 0.10 | 0.2 | 0.3 | 0.004 | 0.008 | 0.012 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.029 |
| HE | 2.10 | 2.4 | 2.64 | 0.083 | 0.094 | 0.104 |
| θ | 0° | --- | 10° | 0° | --- | 10° |

7. SOLDERING FOOTPRINT



单击下面可查看定价，库存，交付和生命周期等信息

[>>LRC\(乐山无线电\)](#)